



EMIF06-MSD03F3

6-line low capacitance IPAD™ for micro-SD card
with EMI filtering and ESD protection

Features

- EMI low-pass filter
- ESD protection ± 15 kV (IEC 61000-4-2)
- Integrated pull up resistors to prevent bus floating when no card is connected
- 208 MHz clock frequency compatible with SDR104 mode (SD3.0)
- Lead-free package
- Coated version option on request
- Electrical card detect option

Benefits

- Low power consumption
- Easy layout thanks to smart pin-out configuration
- Very low PCB space consumption
- High reliability offered by monolithic integration
- Reduction of parasitic elements thanks to CSP integration

Complies with the following standards:

- IEC 61000-4-2 level 4:
 - 15 kV (air discharge)
 - 8 kV (contact discharge)

Application

Micro (T-Flash) secure digital memory card in:

- Mobile phones
- Communication systems

Description

The EMIF06-MSD03F3 is a highly integrated device based on IPAD technology offering two functions: ESD protection to comply with IEC standard, and EMI filtering to reject mobile phone frequencies.

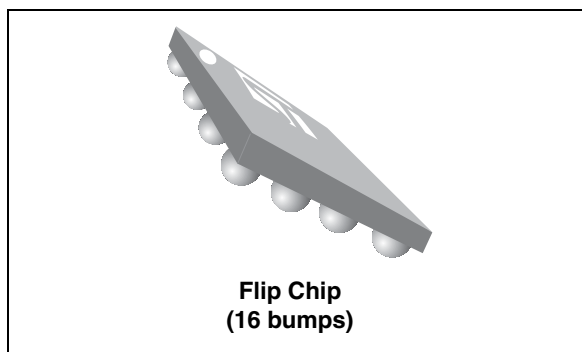
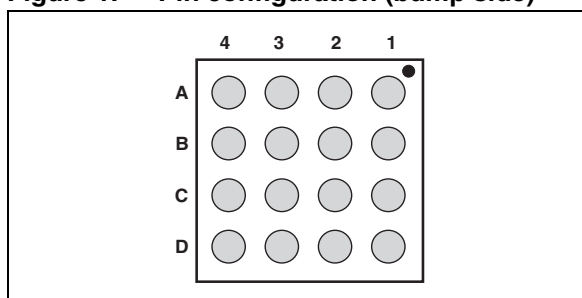


Figure 1. Pin configuration (bump side)



TM: IPAD is a trademark of STMicroelectronics

1 Characteristics

Table 1. Absolute ratings (limiting values)

Symbol	Parameter	Value	Unit
V _{PP}	ESD discharge IEC 61000-4-2, level 4		
	air discharge, card side	15	kV
	contact discharge, card side	8	
	air discharge, IC side	2	
contact discharge, ICside	2		
T _j	Maximum junction temperature	125	°C
T _{op}	Operating temperature range	- 40 to + 85	°C
T _{stg}	Storage temperature range	- 55 to + 150	°C

Figure 2. EMIF06-MSD03F3 configuration

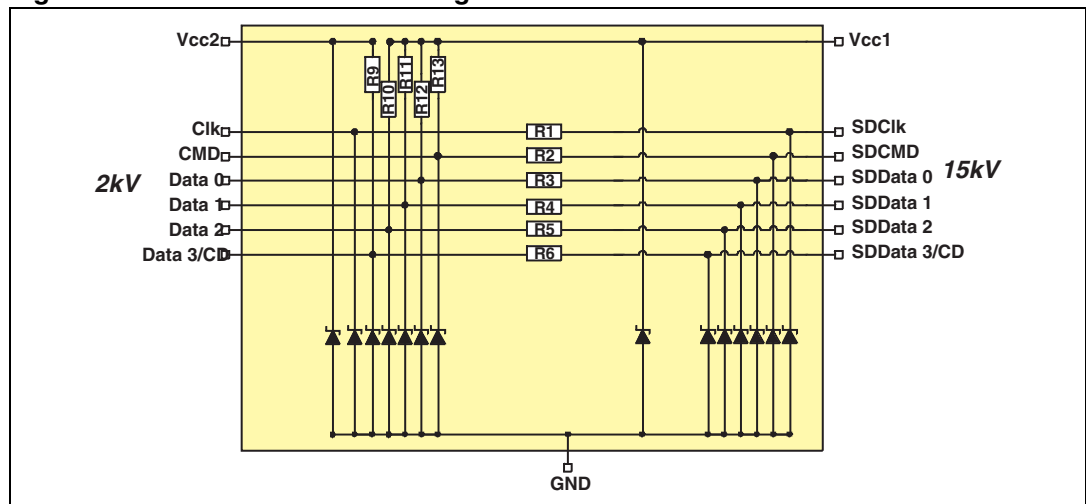


Table 2. Pin configuration

Pin	Signal	Pin	Signal
A1	DATA0	C1	CMD
A2	DATA1	C2	V _{cc2}
A3	SDDATA1	C3	V _{ss}
A4	SDDATA0	C4	SDCMD
B1	CLK	D1	DATA3/CD
B2	V _{cc1}	D2	DATA2
B3	V _{ss}	D3	SDDATA2
B4	SDCLK	D4	SDDATA3/CD

Table 3. Electrical characteristic

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{BR}	Breakdown voltage	$I_R = 1 \text{ mA}$	14	16		V
I_{RM}	Leakage current at V_{RM}	$V_{RM} = 3 \text{ V}$			0.1	μA
R1, R2, R3, R4, R5, R6	Serial resistance	Tolerance $\pm 10 \%$, matching $\pm 2 \%$		40		Ω
R9, R10, R11, R12	Pull-up resistance	Tolerance $\pm 10 \%$, matching $\pm 2 \%$		50		k Ω
R13	Pull-up resistance on CMD	Tolerance $\pm 10 \%$		15		k Ω
C_{line}	Data line capacitance	$V = 0 \text{ V}$, $F = 10 \text{ MHz}$, $V_{OSC} = 30 \text{ mV}$		10	12	pF
		$V = 1.8 \text{ V}$, $F = 10 \text{ MHz}$, $V_{OSC} = 30 \text{ mV}$		7.5	10	
		$V = 2.9 \text{ V}$, $F = 10 \text{ MHz}$, $V_{OSC} = 30 \text{ mV}$			9	
F_0	Cut-off frequency	S21 = -3 dB		550		MHz
t_R, t_F	Rise and fall time	$C_{load} = 10 \text{ pF}$, low-ref = 0.58 V, high-ref = 1.27 V, $V_{DDIO} = 1.8 \text{ V}$		0.98		ns

Figure 3. S21 attenuation measurements

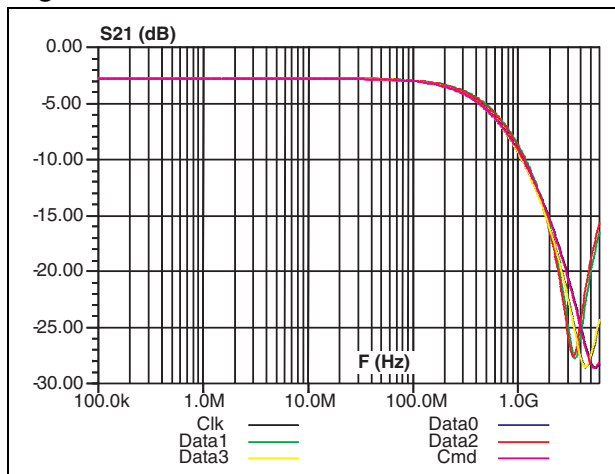


Figure 4. Analog crosstalk measurements

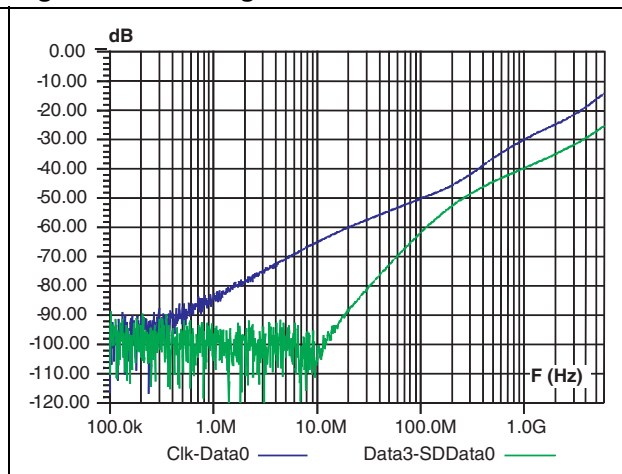


Figure 5. Line capacitance versus applied voltage (typical values)

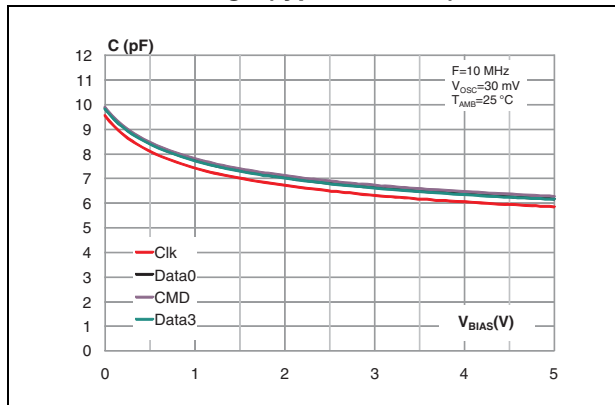


Figure 6. Line capacitance versus frequency (typical values)

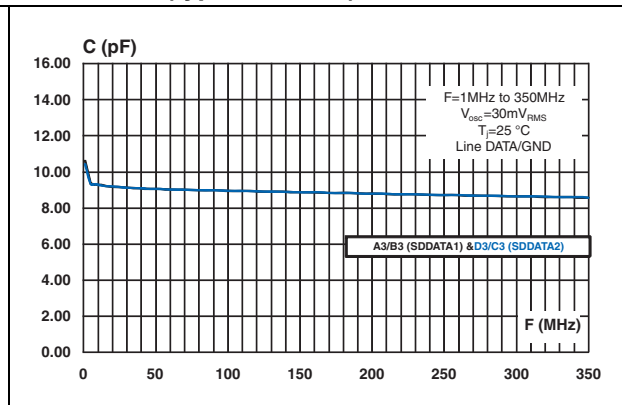


Figure 7. Digital crosstalk measurements

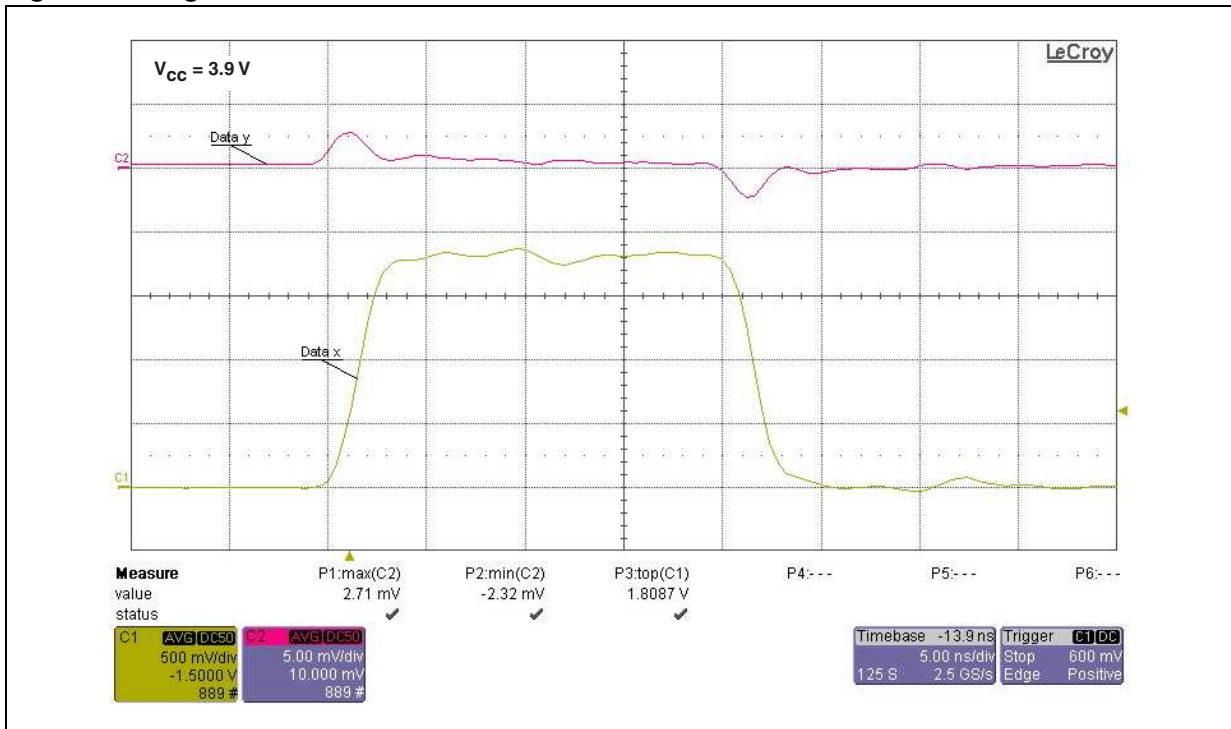


Figure 8. ESD response to IEC 61000-4-2 (+8 kV contact discharge) on one input and one output

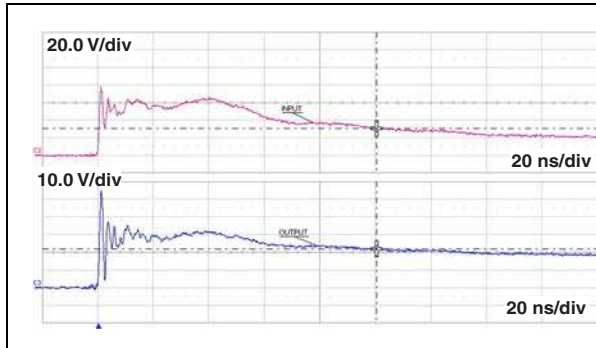
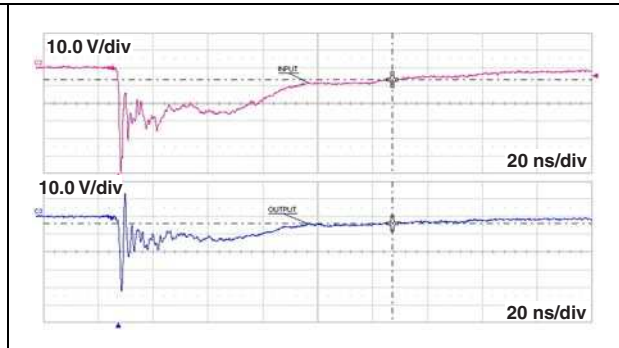
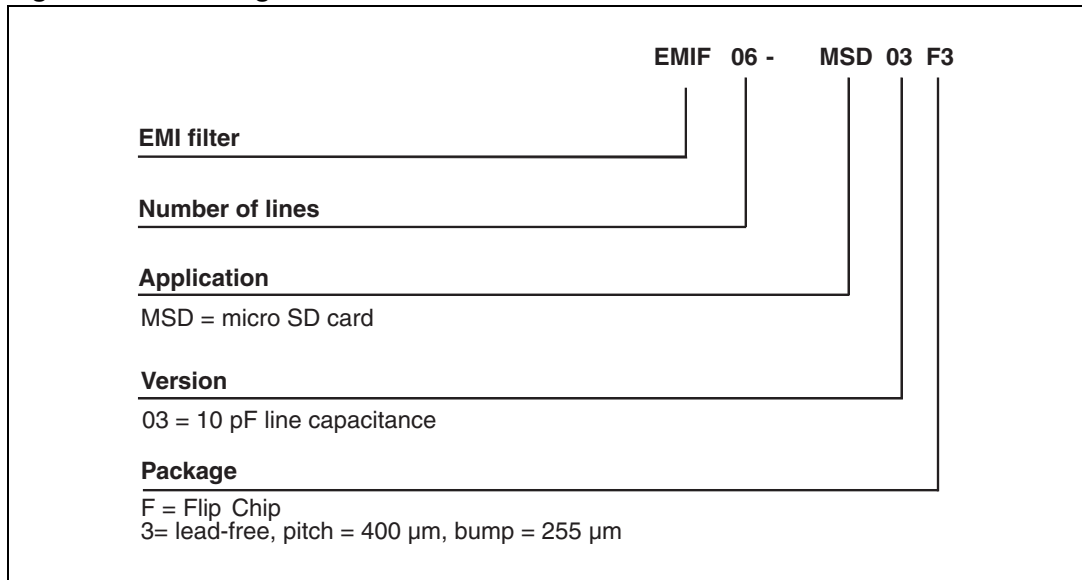


Figure 9. ESD response to IEC 61000-4-2 (-8 kV contact discharge) on one input and one output



2 Ordering information scheme

Figure 10. Ordering information scheme



3 Package information

- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 11. Package dimensions

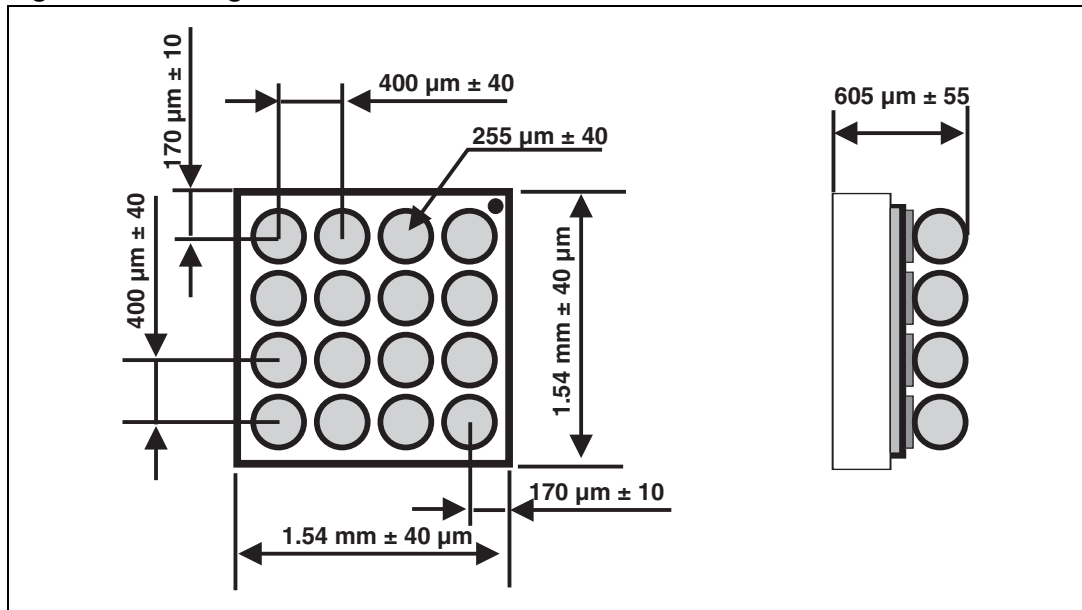


Figure 12. Footprint

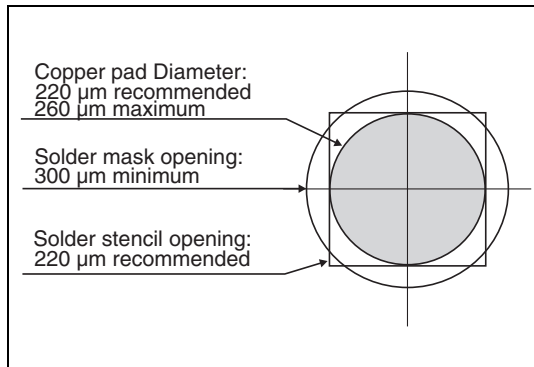


Figure 13. Marking

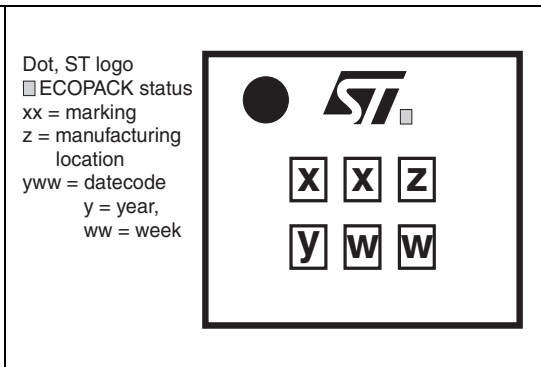
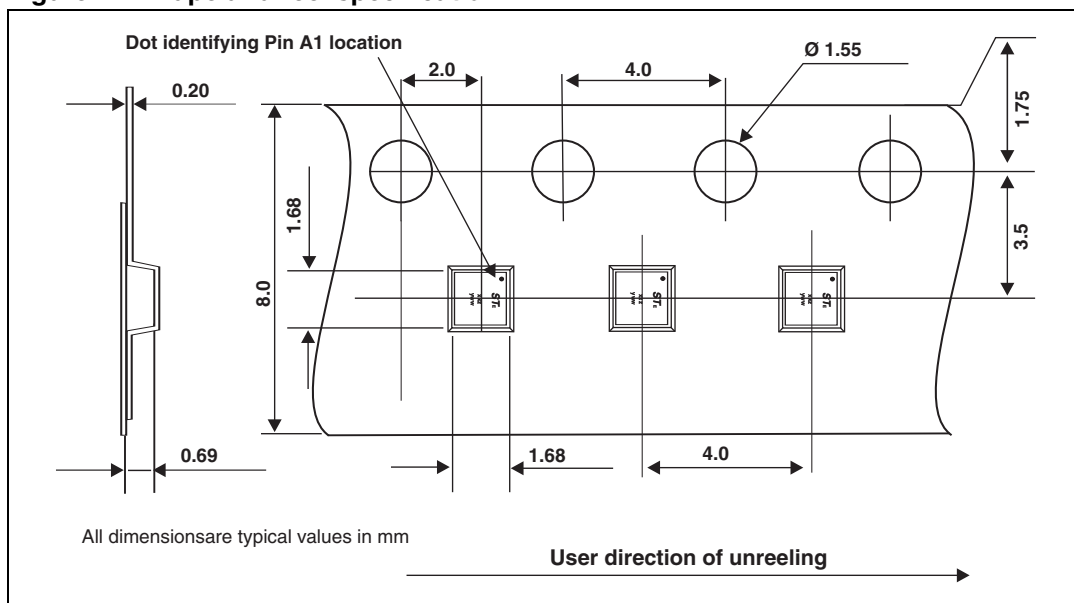


Figure 14. Tape and reel specification



4 Ordering information

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF06-MSD03F3	JV	Flip Chip	3.2 mg	5000	Tape and reel 7"

Note:

More information is available in the application notes:

AN2348: "Flip Chip: Package description and recommendations for use"

AN1751: "EMI Filters: Recommendations and measurements"

5 Revision history

Table 5. Document revision history

Date	Revision	Changes
11-Jul-2011	1	First issue.

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